Design of Low-Cost Portable Ultrasound Systems: Review

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 *Abstract***- Ultrasound continues to be one of the major imaging modalities used for the diagnosis and treatment of a number of medical conditions. Therefore emphasis on innovation is continually increasing the quality of the ultrasound systems. However focus is just beginning to shift into the lowcost and portable applications of ultrasound. These systems present interesting constraints which must be considered to transform a standalone system into a portable version. This review takes a look at some of the attempts which have been published, as well as some of the issues which have still yet to be resolved. In conclusion, low-cost portable ultrasound has the capability to be developed and commercialized, but until a suitable replacement to piezoelectric crystals has been developed (possibly CMUTs?) low-cost portable ultrasound system will be held back by the high cost burden associated with the cost of piezoceramics.** ¹

I. INTRODUCTION

INCE its beginning in the 1950's medical ultrasound has continued to grow and mature. As standalone machines become increasingly complex, a new segment of the engineering community is doing just the opposite, trying to make medical ultrasound machines smaller, more power efficient and less costly than they have ever been [1]. s

The market demand for portable ultrasound is becoming larger with applications in developing countries, military, and emergency purposes. According to Harvey Klein, President of Klein Biomedical Consultants, their latest report on the ultrasound market indicated that the handheld-ultrasound market grew by 42% in 2007 to \$565 million [2]. However, Klein the leading Ultrasound industry expert expects the global market to exceed \$1.2 billion in five years. Currently the markets outside of the United States account for 42% of the sales. These figures show the increasing emphasis that the market may place on the miniaturization of medical ultrasound.

However, in order to make ultrasound technology more portable and available at a lower cost a number of design parameters need to be addressed.

First, transducer design on stand - alone machines typically consists of intricate transducer arrays created with highly sensitive piezoceramics. These generally have a high cost associated with them, and therefore are not directly suited for low - cost applications.

Secondly, the hardware implementation of ultrasound transmit and receive circuitry needs to be modified to become compatible with the portability requirements. Traditionally ultrasound technology usually relies upon high voltages and currents to drive the transducer, as well as sensitive circuitry to receive the acoustic waveform. Therefore to make a system portable lower voltage and current sources must be used. Also the circuitry must be simplified in order to comply with the smaller size constraints.

Finally, the beamforming algorithm which is used to steer and focus acoustic signals must be simplified for use on a portable system. To meet these needs, tradeoffs must be made in order to create the machine small enough to satisfy its portability and cost requirements, but also with enough resolution to provide the medical practitioner an image that can be clinically useful.

II. TRANSDUCER DESIGN

Until advances in phase array transducers, single element probes were constructed and attached to mechanical motors in order to produce a 2 - D image. However, this method had many problems including slow scanning, mechanical fragility, and insensitivity [3]. Due to optimization of the construction of array transducers [4], the mechanical arrays are now more limited in usage.

Initially 1 - D array were created with an array of N elements (typically 64 - 128 elements), this was pragmatically useful because they translate well onto a 2D display and the designer had essentially "unlimited" space to design their transducer [3]. However, limitations on imaging quality lead to the belief that a 3 - D image would be more beneficial. In order to obtain these improved images N x N arrays were need which increased all parameters by a factor of N. Therefore, one of the major challenges becomes the creation of a PCB layout that will facilitate all the array elements.

Girard *et al.* at the University of Virginia [3] developed a low - cost method for the creation of a printed circuit board (PCB) to facilitate 1024 surface pads for each element. A gold plated polyester sheet covered all 1024 transducers to complete the connection. Due to the PCB traces that crossed over each other, crosstalk was a large portion of the overall signal. However this design was sufficient to generate a proof of concept.

Eames *et al.* [5] furthered the work by Girard *et al.* at the University of Virginia with the creation of a 60 x 60 (3600 element) transducer array. Eames *et al.* looked to improve upon the problems Girard *et al.* faced with crosstalk in their device by creating 3600 straight through holes as seen in figure 1.

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Fig. 1. Diagram of the through hole electrical connections used by Eames *et al.* [5]

Eames *et al.* design resulted in a slightly lower resonance frequency of the piezoceramics than was anticipated, probably due to the element thickness. Further problems such as grating lobes were introduced with the low aspect ratio, which was caused by the dimensions of the transducer.

Transducer design has continued to progress and the type of transducer greatly depends upon the application of the ultrasound system. The frequency of ultrasound probes can vary roughly between 1 to 10 MHz depending on the application. Most of the systems have th he ability to use transducers that range from 1 to 10 MHz.

TABLE I

Summary of the Piezoelectric Transducer Arrays

Group		Image	Type	Material
Lewis		A - mode	Single Element	$PZT - 4$
Girard Fuller	&	C - Scan	Array (32) x 32)	$PZT - 4$
Eames		C - Scan	Array (64 x(64)	PZT - 5H

However, as progress in micro - fabrication continues capacitive ultrasonic transducers are beginning to compete with piezoelectrics. These capacitive micro - machined ultrasonic transducers (CMUTs) hold the promise of dramatically reducing the cost associated with ultrasonic transducers along with providing revolutionary advances in current technology.

Oralkan *et al.* [6] was the first to present a pulse - echo phased array B - scan sector image using 128 CMUT elements in a 1D transducer array. They also showed evidence that CMUTs can compete with piezoelectrics in terms of efficiency and bandwidth.

An overview of the CMUT technology is shown in figure 2.

A direct current voltage is applied between the membrane and the substrate which pulls the two together by electrostatic forces. The pulsing of which will generate an ultrasonic signal.

Fig. 2. Diagram of a CMUT (from Oralkan et al.) [6]

The 128 element array used by Oralkan et al. was attached to a PCB in a similar fashion to its piezoelectric counterparts. The array showed 100% efficiency in the connection of the transducers compared with only 90% by Girard *et al.* and 98.3% with Eames *et al.*

However, this new technology is not without some current roadblocks. Large electric f fields are required to drive these transducers and the process ca an present some problems. Due to these large electric fields insulating layers can break down and dc bias fields must b e constantly modified to compensate. Also since these transducers respond in a nonlinear fashion, it becomes d difficult to measure the nonlinearity of living tissue [7].

 For low - cost applications C CMUTs continue to offer promise for the field. Even though low - cost designs have been implemented with piezoelectric transducers, they generally provide much of the cost associated with ultrasound systems, still $cost > $1,000$. Therefore in order to create a truly low - cost solution, new technology such as CMUTs has to be developed to the point of commercialization.

III. TRANSMIT CIRCUITRY DESIGN

Another major hurdle in the increase in portability is the design of power system which ef ffectively use low voltage sources. Traditional ultrasound systems rely on high voltages and currents to drive the piezoelectric transducers.

Owen *et al.* [8] has developed a 12 lb plug - in class D switch mode amplifier to drive single element high intensity focused ultrasound transducers. The system provided 140 W of acoustic energy to a 70% efficient PZT transducer. Owen el al. concluded their device was s comparable to available commercial applications.

According to Lewis *et al.* [9] the majority of ultrasound drivers and RF amplifiers are generally built with an output impedance of 50 ohms. In order to obtain the maximum power transfer matching circuitry must be used to transfer power to the transducer. However, in matching impedances which are generally complex, systems incur additional costs and complexity. Lewis *et al.* worked to develop driving $circuitry$ with an output impedance of 0.3 ohms which transferred power with 95 % efficiency to the transducer.

Fig. 3. Block Diagram of the circuitry used be Lewis et al. to provide low output impedance [9]

The system is composed of six 9.6 V NiCad batteries which can provide voltages to the transducer ranging from 19.2 to 57.6 V. The battery life of the system ranged from 0.7 hours to 1.7 hours. The system was able to provide 50W of power to a 1.54 MHz transducer with impedance matching. The total cost of the system was \$150.00, 80% of which was associated with the battery costs.

IV. RECEIVE CIRCUITRY DESIGN

The receive circuitry has to be further adapted for the low cost, portable use with tradeoffs that provide adequate signals but also increase the usability and battery life. The Sonic Window, a low - cost portable ultrasound system developed by Fuller *et al.* [1], has been looking to accomplish this. The project takes many of the suggestions from the transducer design, electronics, and beamforming (to be discussed later) into account in the design of this low - cost, p portable system.

Fig. 4. Block Diagram of the Sonic Window by Fuller et al. [1]

The system was implemented with a 2D array (32 x 32) very similar to the array introduced by Girard et al. Each receive channel consists of on - chip transmit protection shunting device, a variable gain preamplifier (figure 5), a bandpass filter, a sample and hold circuit, an d an analog - to digital circuit with memory. protection devices on the chips eliminates the need for bulky, expensive power consuming switching elements. By placing the transmit

The design of the system allows the requirements of the ADC and the sample - and - hold - circuits to be stripped down. For instance, the S/H circ uitry consists of two S/H units, which sample one quarter period with respect to the center frequency of the received pulse. approximates the I and Q comp onents of the RF signal according the Direct Sampled In - Phase/Quadrature beamforming technique (to be discussed later). Finally since the system only generates C - scan images the sample - and hold circuits are only required to capture one sample per image. These properties of the syst em allow ADC conversion rates to be as low as 10 kHz with much less memory being used. This process

Fig. 5. Schematic of the single stage preamplifier used by Fuller et al. The gain can be adjusted between 30 dB and 85 dB by adjusting RecvGain [1]

The verification testing which was performed using the Sonic Window showed the initial technology to be a promising alternative to conventional ultrasound system. However, the system was not without problems that included routing between the individual elements and their respective receive channels, which resulted i n a 6.74% channel loses. This could have occurred due to the long PCB traces that induced parasitic inductances, capacitances, and resistances. These problems with the traces further induced low signal - to - noise ratio which caused poor contrast and image artifacts in the signal.

Additional methods for incorporating receive circuitry include USB 2.0 functionality [10] and compatibility with proprietary software packages from the main commercial portable ultrasound companies Sonosite and General Electric.

V. BEAMFORMING ALGORITHMS

Initially in order to form the $2 - D B$ - mode image, mechanical transducers were used to mechanically rotate the transducer [11]. Analog delay lines and fast analog processing units allowed the advent of phased array systems in the 1980's. However, after advances in silicon technology which lead to more sophisticated analog - digital circuits, beamforming algorithms were programmed digitally. These digital signals soon replaced their m mechanical counterparts.

Traditionally three different methods were used to implement a time delay. intermediate frequency [12]. 2) U Upsampling the incoming RF modulation onto an

signal using an interpolation filter [13]. 3) Nonuniform sampling of the RF signal according to the needed time delay.

The oversampling method of implementing time delays soon became the popular method to implement time delays because of their relative simplicity and ease of integration. General Electrical patented a delta - sigma oversampling A/D, which suffers from a major flaw which reduce image quality significantly.

Single Bit Digital Multi-Bit Digital Analog Transducer Frame Buffer Lowpass Filter
Decimate Transducer $\Delta \Sigma$ A/D Doppler ĹΣ Variable Length 128 Delay Lines M-Mode Channels Audio

Fig. 6. Diagram of the Delta - Sigma Oversampled Beamformer [11]

Freeman *et al.* [11] corrected this problem with the creation of the Delta - Sigma Oversampled ultrasound beamformer. This method, now serves as one of the best low cost beamforming options available.

 Ranganathan *et al.* [14] looked to further develop beamforming algorithms by reducing the image quality for a large tradeoff in cost. The goal was to determine the simplest beamforming algorithm which yielded image quality, thus developing the direct sampled I/Q (D SIQ) algorithm.

Fig. 7. Diagram of the Direct Sampled I/Q Beamforming Algorithm [14]

The beamforming algorithm which was used was found to dramatically reduce the cost and burden on the system. The DSIQ beamforming algorithm was found to b be robust enough to be usable for the majority of applications.

VI. CONCLUSION

Based upon the designs which have been discussed in the article ultrasound technology is reaching a p point where low cost options will soon become available. The main driving force behind the low – cost movement may be the introduction of CMUT technology in ultrasonic transducers. The standardization of these cost - effective transducers will then

be coupled with the work that has been done and previously examined in this article. However, if the CMUT technology fails to materialize concerns over the feasibility of the low cost ultrasound will continue, as the piezoelectric crystals constitute a majority of the c ost associated with the development of ultrasound systems.

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